

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Hardware Kits

HK1



- HK1 contains 2 SSR mounting screws 8-32 x 3/8
- For use with all Crydom heat sinks (Except HS501DR)

HK₂



- HK2 contains grounding screw 10-32 x 3/8 and 2 bracket screw 6-32 x 1/4
- For use with HS351, HS301, HS271, HS201 HS172, HS151 and HS122 heat sink

AGENCY APPROVALS

Agency Approvals



ANNEX - ENVIROMENTAL INFORMATION

The environmental information disclosed in this annex including the EIP Pollution logo are in compliance with People's Republic of China Electronic Industry Standard SJ/T11364 – 2006, Marking for Control of Pollution Caused by Electronic Information Products.

Part Name	Toxic or hazardous Substance and Elements							
	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr (VI))	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)		
Semiconductor die	Х	0	0	0	0	0		
Solder	Х	0	0	0	0	0		

附件 - 环保信息

此附件所标示的包括电子信息产品污染图标的环保信息符合中华人民共和国电子行业标准 SJ/T11364 - 2006, 电子信息产品污染控制标识要求。

部件	有毒有害物质或元素							
名称	铅	汞	镉	六价铬	多溴联苯	多溴二苯醚		
	(Pb)	(Hg)	(Cd)	(Cr (VI))	(PBB)	(PBDE)		
半导体芯片	X	0	0	0	0	0		
焊接点	Х	0	0	0	0	0		



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